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(Rev. 10/02)

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PATENTS ONLYU.S. DEPARTMENT OF COMMERCE  
U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Paul Y.S. Lin

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: 6/15/2004

## 2. Name and address of receiving party(ies)

Name: Lite-On Technology Corporation

Internal Address:

Street Address: 22 Fl., 392, Ruey Kuang Road,  
Neihu Dist.

City: Taipei 114, Taiwan, R.O.C.

Additional name(s) & address(es) attached? ☐ Yes ☒ No

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s) 5,266,817

Additional numbers attached? ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Morton J. Rosenberg, Esq.

Internal Address: Rosenberg, Klein &amp; Lee

Street Address: 3458 Ellicott Center Drive,  
Suite 101

City: Ellicott City State: MD Zip: 21043

## 6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

- ☐ Enclosed  
☒ Authorized to be charged to deposit account

## 8. Deposit account number:

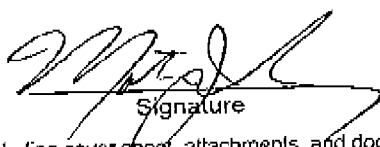
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## 9. Signature.

Morton J. Rosenberg

Name of Person Signing

  
Signature

13 July 2004

Date

Total number of pages including cover sheet, attachments, and documents: 2

Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks, Box Assignments  
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PATENT

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**ASSIGNMENT DEED**

This Assignment agreement is applicable to an invention entitled (Invention Title) PACKAGE STRUCTURE OF MULTI-CHIP LIGHT EMITTING DIODE

The PATENT RIGHTS referred to in this agreement are:

- (Check one) ☐ a Patent Application for the invention, executed by the ASSIGNOR(s) concurrently with this Assignment
- ☐ U.S. Patent Application Serial No. \_\_\_\_\_, filed \_\_\_\_\_
- ☒ U.S. Patent No. 5,266,817, issued NOVEMBER 30, 1993

The PATENT RIGHTS assigned under this agreement are:

- (Check one) ☒ U.S. Patent rights only
- ☐ worldwide Patent rights. In this case, the Assignee shall have the right to claim the benefit of the filing date of any U.S. Patent Application identified above.

The ASSIGNOR(s) referred to in this agreement (or are):

(Full name of sole or first ASSIGNOR) PAUL Y.S. LIN (FAMILY NAME IS LIN)

(Address) 12<sup>TH</sup> FL., NO. 25, SEC. 1, TUNGHUA S. RD., TAIPEI, TAIWAN

(Full name of second joint ASSIGNOR (IF ANY)) \_\_\_\_\_

(Address) \_\_\_\_\_

(Full name of third joint ASSIGNOR (IF ANY)) \_\_\_\_\_

(Address) \_\_\_\_\_

The First ASSIGNEE referred to in this agreement is:

(Name of Assignee) LITE-ON TECHNOLOGY CORPORATION (CHAIRMAN: RAYMOND SOONG; FAMILY NAME IS SOONG)

(Address of Assignee) 22<sup>FL.</sup>, 392, RUEY KUANG ROAD, NEIHU DIST., TAIPEI 114, TAIWAN, R.O.C.

The Second ASSIGNEE referred to in this agreement is:

(Name of Assignee) \_\_\_\_\_

(Address of Assignee) \_\_\_\_\_

The Third ASSIGNEE referred to in this agreement is:

(Name of Assignee) \_\_\_\_\_

(Address of Assignee) \_\_\_\_\_

The First ASSIGNEE is:

- (Check one) ☐ an individual
- ☐ a partnership
- ☒ a Corporation of TAIWAN, R.O.C. (State of Country)

The Second ASSIGNEE is:

- (Check one) ☐ an individual
- ☐ a partnership
- ☐ a Corporation of \_\_\_\_\_ (State of Country)

The Third ASSIGNEE is:

- (Check one) ☐ an individual
- ☐ a partnership
- ☐ a Corporation of \_\_\_\_\_ (State of Country)

The ASSIGNOR(S), in consideration of other good and valuable consideration, receipt of which is acknowledged, have and do hereby assign the following to each ASSIGNEE; their successors and assigns:

the full and exclusive right to the invention  
an equal interest in and to the entire right, title and interest in and to the PATENT RIGHTS; and  
the right to claim priority under 35 U.S.C. 119, based on any earlier foreign applications for this invention.

As to all U.S. Patent Applications assigned under this Agreement, the ASSIGNOR(s) hereby authorized(s) and requests the Commissioner of Patent and Trademarks to issue all Letters Patent to the ASSIGNEE(s) as the ASSIGNEE(s) of an equal interest in the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE(s), their successors and assigns.

Further, the ASSIGNOR(s) agree(s) to communicate to said ASSIGNEE(s), or their representatives, any facts known to the ASSIGNOR(s) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent be issued to said ASSIGNEE(s), make all rightful others and generally do everything necessary or desirable to aid said ASSIGNEE(s), their successors and assigns, to obtain and enforce proper protection for said invention.

FOR:

By:

PAUL Y.S. LIN (FAMILY NAME IS LIN)

Title:

Date: JUNE 15, 2004